## IN THE CLAIMS

## Please enter the pending claims as follows:

1	1.	(Previously P	resented)	A broad-ar	gle multila	ayer (ML) n	nirror
2	comprising a multiple layer structure to provide uniform reflectivity over a wide						
3	range of incident angles with small phase shifts, the structure comprising 36 bi-						
4	layers wherein Molybdenum has a thickness of 2.4 – 11.3 nm and Silicon has a						
5	thickness of 3.5 – 10.4 nm.						
6							
1 2 3		(Original) eptance angle	The ML mirr				_
1		(Original) ximately 17%.	The ML mirr	or of claim 2	2 wherein t	the loss of r	eflectivity is
3							
1	4.	(Original)	The ML mirr	or of claim 1	l wherein t	the ML mir	ror increases
2	the relative phase shift.						
3							
4							

5. (Original) The ML mirror of claim 1 wherein the ML mirror comprises 1 a 13.5nm central wavelength. 2 3 6. (Previously Presented) The ML mirror of claim 1 wherein the structure 1 comprises: a 13.5nm central wavelength. 2 3 7. (Previously Presented) The ML mirror of claim 1 wherein the bi-layers i in the structure have a variable thickness. 2 3 The ML mirror of claim 1 wherein the structure 8. (Previously Presented) 1 2 includes additional bi-layers. 3 9. (Previously Presented) The ML mirror of claim 8 wherein the 1 additional bi-layers in the structure are comprised of Mo/Si bi-layers. 2 3 10. (Previously Presented) The ML mirror of claim 8 wherein the 1 additional bi-layers in the structure have a variable thickness. 2 3 11. 1 (Previously Presented) An optical system having an extreme ultraviolet (EUV) radiation source, the system comprising: 2 a mask; 3 a wafer; and 4

a plurality of reflecting surfaces for imaging the mask on the wafer, 5 wherein one or more of the plurality of reflecting surfaces includes a broad-angle 6 multilayer (ML) mirror having a multiple layer structure to provide uniform 7 reflectivity over a wide range of angles with small phase shifts, the ML mirror 8 comprising 36 bi-layers wherein Molybdenum has a thickness of 2.4 – 11.3 nm 9 and Silicon has a thickness of 3.5 – 10.4 nm. 10 11 12. 1 (Original) The system of claim 11 wherein the plurality of reflecting surfaces comprises six mirrors. 2 3 1 13. (Original) The system of claim 11 wherein the ML mirror provides an acceptance angle in excess of 20° without a significant loss of reflectivity. 2 3 14. (Original) The system of claim 13 wherein the ML mirror has a loss of 1 2 reflectivity of approximately 17%. 3 15. 1 (Original) The system of claim 11 wherein the ML mirror increases the 2 relative phase shift. 3 1 16. (Original) The system of claim 11 wherein the ML mirror comprises a 2 13.5 nm central wavelength. 3

17. (Previously Presented) The system of claim 11 wherein the structure 1 comprises: a 13.5nm central wavelength. 2 3 18. (Previously Presented) The system of claim 11 wherein the bi-layers 1 have a variable thickness. 2 3 19. (Previously Presented) The system of claim 11 wherein the structure 1 includes more than thirty-six bi-layers. 2 3 20. (Previously Presented) ì An optical system having an extreme ultraviolet (EUV) radiation source, the system comprising: 2 3 a mask; a wafer; and 4 a plurality of reflecting surfaces for imaging the mask on the wafer, 5 including: a mirror having a multiple layer structure to provide uniform 6 reflectivity over a wide range of angles with small phase shifts, the mirror 7 8 comprising 36 bi-layers wherein Molybdenum has a thickness of 2.4 - 3.7 nm except for a thicker bi-layer 1 nearest substrate and Silicon has a thickness of 3.5 -9 10 4.1 nm except for thicker bi-layers 3, 5, and 15. 11 12 21. (Previously Presented) The system of claim 20 wherein the mirror 1 provides an acceptance angle in excess of 20° without a significant loss of 2 reflectivity. 3 Application Serial No.: 10/811,607 Attorney's Docket No. 42P19028

- 1 22. (Previously Presented) The system of claim 21 wherein the mirror has
- 2 a loss of reflectivity of approximately 17%.

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- 1 23. (Previously Presented) The system of claim 20 wherein the mirror
- 2 comprises a 13.5nm central wavelength.

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- 1 24. (Previously Presented) The system of claim 20 wherein the structure
- 2 comprises: a 13.5nm central wavelength.

3

- 1 25. (Previously Presented) The system of claim 20 wherein the bi-layers
- 2 have a variable thickness.

3

- 1 26. (Previously Presented) The system of claim 20 wherein the structure
- 2 includes more than thirty-six bi-layers.